**Trigger Devices** 

Panasonic

# **MA2B001**

### Silicon planar type trigger device

Thyristor TRIAC trigger circuit

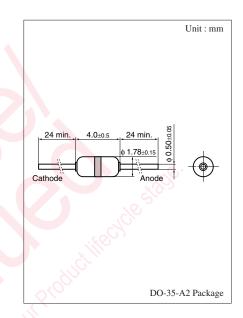
#### Features

- Satisfactory symmetry of breakover voltage  $V_{BO}$
- $\bullet$  Large output voltage  $V_{O}$  and small breakover current  $I_{BO}$

Absolute Maximum Ratings $T_a = 25^{\circ}C$						
Parameter	Symbol	Rating	Unit			
Power dissipation (Average)	P <sub>D(AV)</sub>	150	mW			
Peak current *1	I <sub>P</sub>	2.0	А			
Operating ambient temperature *2	T <sub>opr</sub>	100	°C			
Storage temperature	T <sub>stg</sub>	-55 to +125	°C			

Note) \*1:  $T_a < 50^{\circ}$ C, t = 10 µs, repetitive frequency 60 Hz

\*2: Maximum ambient temperature during operation

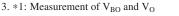


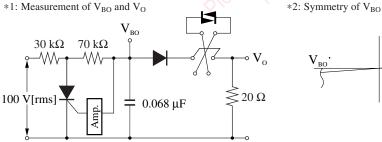
#### Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Breakover voltage *1	V <sub>BO</sub>	I = I <sub>BO</sub>	28		36	V
Output voltage *1	vo vo		4.0	7.0		V
Breakover current	I <sub>BO</sub>	V = V <sub>BO</sub>			50	μΑ
Temperature coefficient of	T.C.(V <sub>BO</sub> )	NOT Str		0.1		%/°C
breakover voltage		10 <sup>11</sup> 11 <sup>2</sup>				
Breakover voltage deviation *2	$\Delta V_{BO}$				3.5	V

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

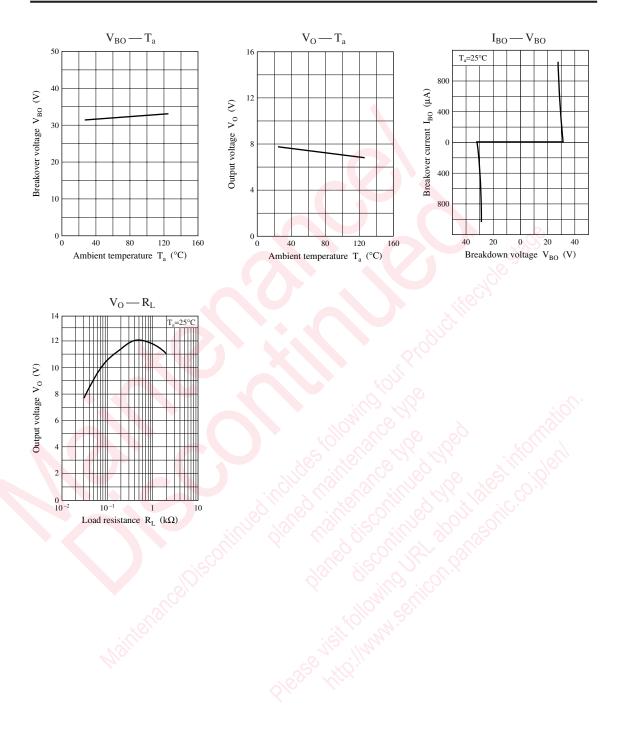
2. Absolute frequency of input and output is 100 MHz.







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